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Contact Type: **Socket**

Wire Size: **.32 – .13 mm²**

Contact Mating Area Plating Material: **Gold**

Connector & Contact Terminates To: **Wire & Cable**

Features

Product Type Features

Applied Pressure	Standard
Connector & Contact Terminates To	Wire & Cable
Product Type	Contact

Electrical Characteristics

Termination Resistance	7 mΩ
Insulation Resistance	5000 MΩ
Operating Voltage	60 VDC
Dielectric Withstanding Voltage	750 V

Contact Features

Wire Contact Termination Area Plating Material	Gold Flash
	30 – 30 μin
Contact Base Material	Phosphor Bronze
Contact Type	Socket
Contact Mating Area Plating Material	Gold
Contact Current Rating (Max)	3 A

Termination Features

Termination Method to Wire & Cable	Crimp
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Mechanical Attachment

Wire Insulation Support	With
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Dimensions

Accepts Wire Insulation Diameter Range	.9 – 1.55 mm [.035 – .061 in]
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Wire Size	.32 – .13 mm ²
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Usage Conditions

Operating Temperature Range	-40 – 80 °C
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Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
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EU ELV Directive 2000/53/EC	Compliant
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China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
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EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUL 2019 (201) Candidate List Declared Against: JAN 2019 (197) Does not contain REACH SVHC
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Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
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Solder Process Capability	Not applicable for solder process capability
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Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

Compatible Parts